# 504033173 10/03/2016

# PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
CHAO-HSUING CHEN	09/29/2016
FU-JIER FAN	09/29/2016
YI-HUAN CHEN	09/29/2016
KONG-BENG THEI	09/29/2016
KER-HSIAO HUO	09/29/2016
SZU-HSIEN LIU	09/29/2016

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### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15283722

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DATE SIGNED:	10/03/2016

504033173 PATENT REEL: 039922 FRAME: 0402

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PATENT REEL: 039922 FRAME: 0403

## PATENT ASSIGNMENT

# PARTIES TO THE ASSIGNMENT

Assignor(s):

Chao-Hsuing Chen	
Assignor(s): Fu-Jier Fan	
Assignor(s): Yi-Huan Chen	
Assignor(s): Kong-Beng Thei	
Assignor(s): Ker-Hsiao Huo	
Assignor(s): Szu-Hsien Liu	
Assignee: Taiwan Semiconductor Manufacturing Co., Ltd. No. 8, Li-Hsin Rd. 6, Hsin-Chu Science Park Hsin-Chu, Taiwan 300-77 Republic of China	
AGREEMENT	
WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled	d
"INTEGRATION SCHEME FOR MICROELECTROMECHANICAL SYSTEMS (N	IEMS)
DEVICES AND COMPLEMENTARY METAL-OXIDE-SEMICONDUCTOR (C	MOS)
DEVICES" for which:	

was filed on \_\_\_\_\_; or \_\_\_\_; or

a non-provisional application for United States Letters Patent:

Assignment on the same day as he/she signs the Declaration); or

oximes was executed on even date preparatory to filing (each inventor should sign this

Ц	I hereby author	ze and request my attorney associated with Customer	No	
	107476, to inser	on the designated lines below the filing date and applica	atior	
number of said application when known:				
	U.S. Serial No.			
	filed on	· · · · · · · · · · · · · · · · · · ·		

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for

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United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

2016 - 9, 28 Date

Name 1st Inventor Chao-Hsuling Chen

>016-09-29 Date

Fu-Tier Faw
2nd Inventor Fu-Jier Fan

2016, 69.291 Date

Date

Name

4th Inventor Kong-Beng Thei

2016 09 29 Date

2016 | 9 | 29 Date

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